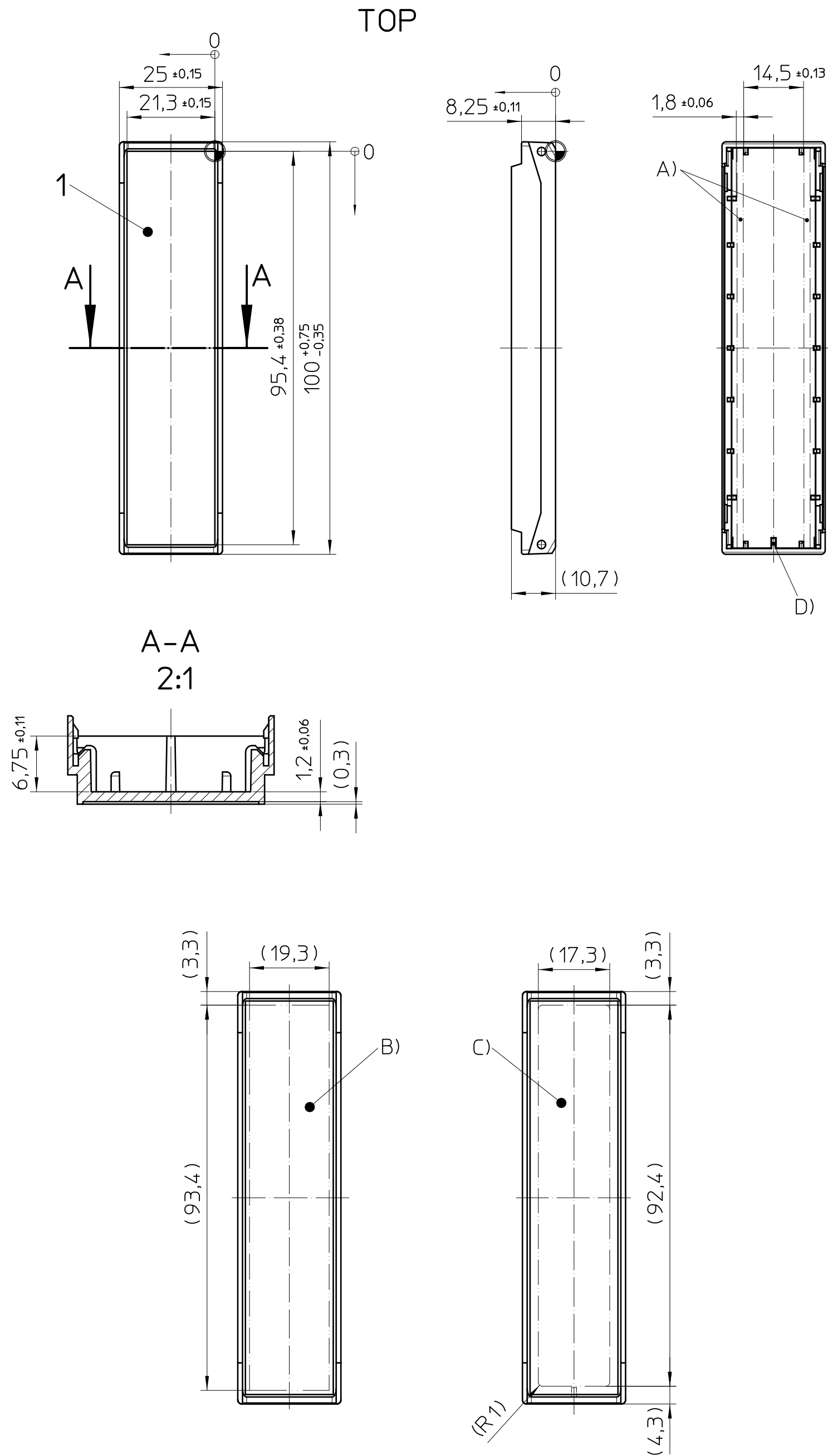
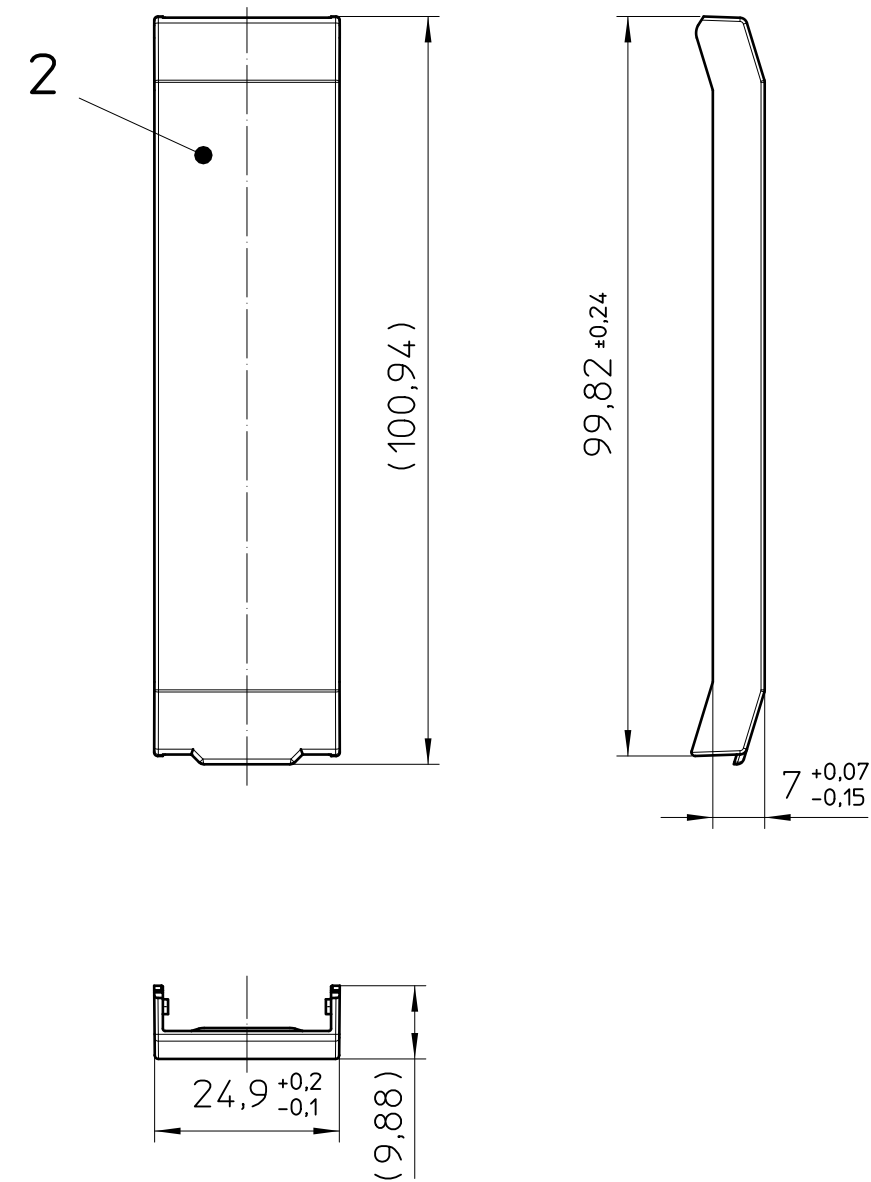


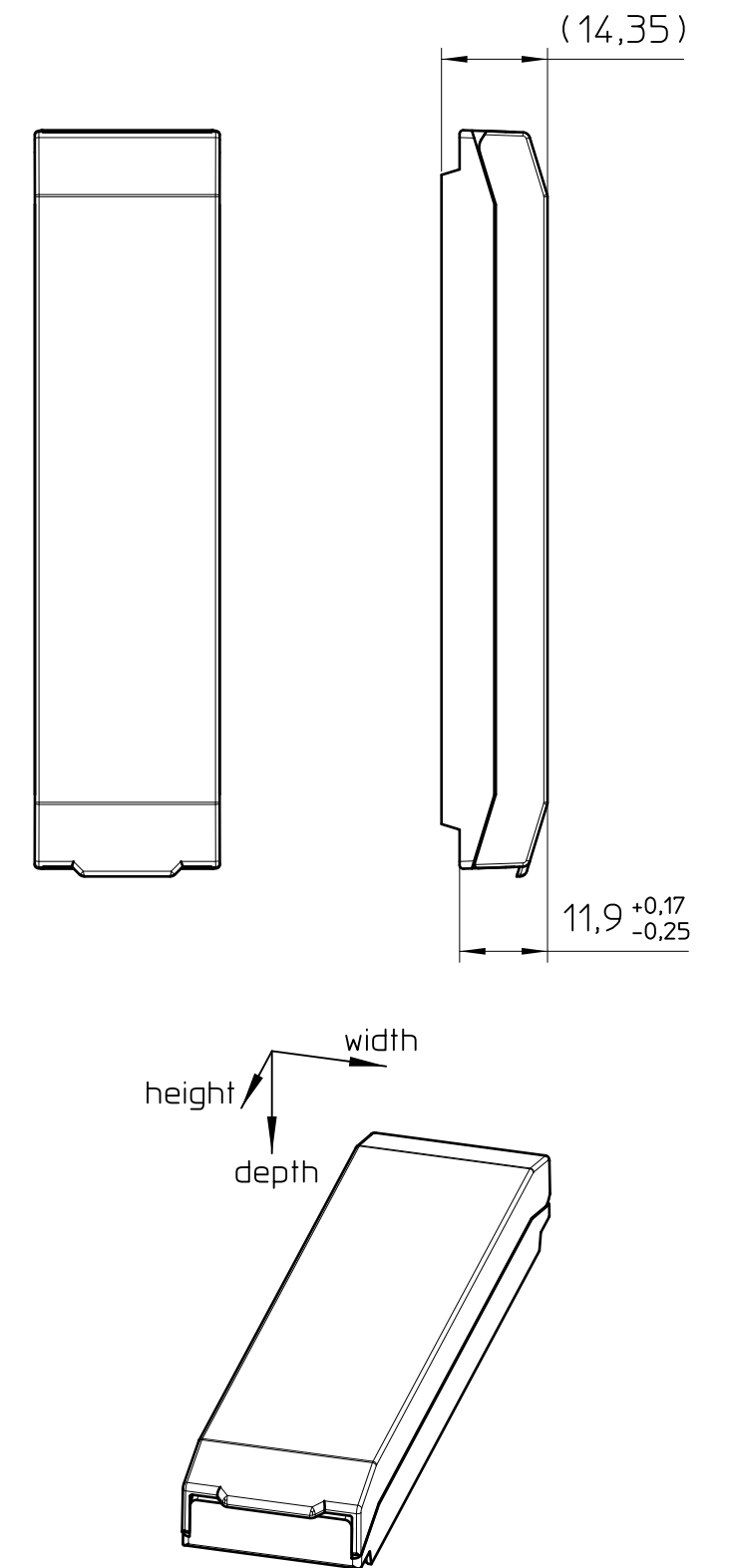
Weitergabe sowie Vervielfältigung dieses Dokuments, Verwertung und Mitteilung seines Inhalts sind verboten, soweit nicht ausdrücklich gestattet. Zuwiderhandlungen verpflichten zu Schadenersatz. Alle Rechte für den Fall der Patent-, Gebrauchsmuster- oder Designeintragung vorbehalten.



HINGED LID



Assembly example



General Information:

- Simplified representation
- Document excluded from change process
- Units are in millimeters [mm] and degrees [°]
- Tolerances apply in a normal climate according to DIN EN ISO 291-23/50-2, PA plastic parts with about 2% (% by weight) moisture content.
-  Workpiece zero point for marking and machining processing
- Tolerances for machining processing,
milling contour to zero point $\pm 0,2$
milling to milling contour $\pm 0,1$
- Machining radii min. R1, further on request
- Tolerances for printing DIN ISO 2768-m
- Web: www.phoenixcontact.com webcode: #1635

Additional Information:

- A) PCB t= 1,6±0,2
- B) Max. marking area, 0,3 recessed, only for pad printing, other printing processes on request.
- C) Max. machining area, 0,3 recessed.
- D) Coding

KIT (not mounted)				
Pos.	QTY	Description	Material	
1	1	TOP	PA	
2	1	HINGED LID	PC	
 DIN A2		document-No. / RI 01067450 / 02	date 30.08.2024	scale 1:1
 PHOENIX CONTACT		ident.-No. 1072377	document-type TECDOC 2D_Productdrawing	
page 1 of 1		description ICS25-TL100X12-5015		